TS00-101C

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Claims are reflected in the listing of the Claims which begins on page 4 of this paper.

Remarks/Arguments begin on page 9 of this paper.

## IN THE TITLE

Please amend the title as follows:

METHOD FOR FORMING A SELF-PASSIVATED COPPER INTERCONNECT STRUCTURE

## IN THE SPECIFICATION

Please add this paragraph before the first paragraph on page 1:

This is a continuation application of U.S. Patent Application 10/207,548 filed on 7/29/02, now allowed.